Nanoprobe Mechanical and Piezoelectric Characterization of ScAl1-xN(0001) Thin Films

Agne Zukauskaite, Esteban Broitman, Per Sandström, Lars Hultman and Jens Birch

Linköping University Post Print

N.B.: When citing this work, cite the original article.

Original Publication:
http://dx.doi.org/10.1002/pssa.201431634
Copyright: Wiley-VCH Verlag
http://www.wiley-vch.de/publish/en/
Postprint available at: Linköping University Electronic Press
http://urn.kb.se/resolve?urn=urn:nbn:se:liu:diva-103830
Nanoprobe mechanical and piezoelectric characterization of Sc$_x$Al$_{1-x}$N(0001) thin films

Agnė Žukauskaitė *, Esteban Broitman **, Per Sandström, Lars Hultman, and Jens Birch

Thin Film Physics Division, Department of Physics, Chemistry, and Biology (IFM), Linköping University, SE-581 83 Linköping, Sweden

Received ZZZ, revised ZZZ, accepted ZZZ. Published online ZZZ. (Dates will be provided by the publisher.)

Keywords: electromechanical characterization, scandium aluminum nitride, nanoindentation, piezoelectric thin films, functional coatings.

* Corresponding author: e-mail agne.zukauskaite@liu.se, Phone: +46 13281232, Fax: +46 13137568
** e-mail esteban.broitman@liu.se, Phone: +46 13 285748, Fax: +46 13137568

Nanoindentation with in-situ electrical characterization is used to investigate piezoelectric scandium aluminum nitride (Sc$_x$Al$_{1-x}$N) thin films with Sc contents up to x=0.3. The films are prepared by reactive magnetron sputtering using Al$_2$O$_3$ substrates with TiN seed layers as bottom electrodes at a substrate temperature of 400 °C. X-ray diffraction shows c-axis oriented wurtzite Sc$_x$Al$_{1-x}$N, where the crystal quality decreases with increasing x. Piezoelectric force microscopy in mapping mode reveals a single piezoelectric polarization phase in all samples. The hardness decreases from 17 GPa in AlN to 11 GPa in Sc$_{0.3}$Al$_{0.7}$N, while reduced elastic modulus decreases from 265 GPa to 224 GPa, respectively. Both direct and converse piezoelectric measurements are demonstrated by first applying the load and generating the voltage and later by applying the voltage and measuring film displacement using a conductive boron doped diamond nanoindenter tip. The Sc$_{0.3}$Al$_{0.7}$N films exhibit an increase in generated voltage in comparison to AlN and a correspondingly larger displacement upon applied voltage, comparable to results obtained by double beam interferometry and piezoresponse force microscopy.

1 Introduction AlN has the highest reported piezoelectric coefficient $d_{33}$=5 pm V$^{-1}$ amongst group IIIA nitrides. It is used in thin film bulk acoustic wave resonator (TFBAR) structures in the telecommunication industry [1]. Recent reports show as much as 400% increase in piezoelectric response when alloying AlN with Sc to create wurtzite Sc$_x$Al$_{1-x}$N with up to x=0.43 [2-4]. Ab initio calculations explain this to be an intrinsic alloying effect, caused by flattening of the energy landscape along the c-axis due to the existence of an unstable hexagonal ScN phase, when the piezoelectric constant $c_{33}$ increases with a simultaneous decrease in the stiffness constant $c_{33}^k$ [5]. Due to competition between the most stable phases – wurtzite AlN and rocksalt ScN – the resulting films are metastable. However, based on mixing enthalpy calculations, wurtzite is the favored structure below x=0.55 [6]. Additionally to piezoelectric properties, mechanical properties of AlN and Sc$_x$Al$_{1-x}$N thin films are of interest in microelectromechanical system (MEMS) applications [7]. The knowledge of the mechanical properties is important for understanding the microstructure and morphology of films deposited under different growth conditions as well as during the operation of sensors or other thin film-based devices in applications, where the film could be exposed to a deliberate or unexpected mechanical stress. High elastic modulus, a typical property of group IIIA semiconductor nitrides, is of interest when high frequency in resonant devices needs to be achieved [8].

Nanoindentation is a technique widely viewed as a standard tool for characterization of mechanical properties, such as hardness and elasticity. However, if the indentation is performed using a conductive indenter tip, in-situ electrical characterization is also possible [9]. Piezoelectric nanoindentation (PNI), a method, where the converse piezoelectric effect is observed when an oscillating voltage is applied and the surface displacement is detected [10] has

Copyright line will be provided by the publisher

Review copy – not for distribution
(pss-logo will be inserted here by the publisher)
recently been introduced as another nanoindentation-based approach to obtain additional information about the material properties. PNI was thus successfully used for electro-mechanical characterization of lead zirconate titanate (PZT) and BaTiO$_3$ ceramics [10]. Nanoindentation can also be used to induce the direct piezoelectric effect in the material by applying load to generate piezo-voltage, as it has been shown in the case of PZT nanoislands and ZnO nanowires [11,12].

Currently, the main techniques used for piezoelectric characterization of thin films are piezoresponse force microscopy (PFM) and double beam interferometry (DBI). However, the interpretation of PFM results is usually quite complex due to the dynamic behavior of the detection system, and the measurement is also sensitive to surface contaminations. The use of DBI is not straightforward due to the need of an advanced sample preparation. On the other hand, both PNI and direct voltage generation during the indentation can be done with existing nanoindentation equipment using a conducting tip, and the only requirement for sample preparation is a bottom electrode under the piezoelectric film.

In this report, we employ a standard nanoindentation setup for mechanical and piezoelectric characterization of Sc$_2$Al$_{1-x}$N thin films. Both direct piezoelectric effect, applying constant load to generate voltage, and converse piezoelectric effect, applying constant DC voltage to induce material displacement (dc PNI) are demonstrated. Wurtzite AlN is used as a reference and its piezoelectric response is compared to Sc$_2$Al$_{1-x}$N with x=0.1, 0.2, and 0.3.

2 Experimental details Magnetically unbalanced reactive DC magnetron sputtering was used to deposit 250-500 nm thick Sc$_2$Al$_{1-x}$N films on Al$_2$O$_3$(0001) substrates with previously grown TiN(111) seed layers serving as bottom electrodes [3]. All growth experiments were performed in a UHV system with a base pressure of 6×10$^{-7}$ Pa. In the case of Sc$_2$Al$_{1-x}$N, the substrate temperature $T_S=400$ °C was used, as previous studies have shown it to provide ScAlN with better dielectric properties [3,13,14]. Reference AlN samples were deposited both at $T_S=400$ and 800 °C. X-ray diffraction (XRD) and transmission electron microscopy (TEM) were used for structural characterization of the films. The composition of the Sc$_2$Al$_{1-x}$N thin films was determined using time-of-flight elastic recoil detection analysis (ToF-ERDA) with a primary ion beam of 40 MeV $^{12}$C$^+$ at the Tandem Laboratory in Uppsala, Sweden. The crystalline quality was evaluated using a Philips Cu Ka x-ray diffraction (XRD) Bragg-Brentano diffractometer in $2\theta$/$\theta$ mode. The polarization phase homogeneity was assessed by means of piezoresponse force microscopy (PFM). The measurements were performed in contact mode using a Dimension 3100 atomic force microscope with a Nanoscope IVa controller at excitation voltage of 10 V and ac frequency 5.6 kHz. An NSG01 conductive Pt-coated Si tip with a resonant frequency of $f_0 \approx 135$ kHz was used. The bottom electrode (TiN layer) was in electrical contact with the grounded microscope stage and the voltage was applied through the tip. Instrument calibration using a periodically poled lithium niobate (PPLN) sample was done prior to measuring the Sc$_2$Al$_{1-x}$N samples to ensure a 180° phase shift between oppositely poled piezoelectric domains.

Characterization of electromechanical and mechanical properties of the films was performed using a Hysitron Triboindenter TI-950. The hardness $H$ and the reduced Young’s modulus $E_r$ were measured using a non-conductive Berkovich diamond tip at 1 mN load at a penetration depth below 10% of the film thickness. To perform electrical measurements a conductive Berkovich boron-doped diamond tip with a resistivity of ~3 Ω-cm was mounted instead. Two different configurations were used to measure the piezoelectric effect, described more in detail previously [11]. In the first configuration (Fig. 1a), the direct piezoelectric effect is detected. Here, nanoindentations under load control with maximum loads $F_{max}$ ranging from 0.1 to 11 mN are made, while the generated piezoelectric voltage is measured as a function of the applied load and displacement using the nanoscale electrical contact resistance (nanoECR™) configuration of the Triboindenter. This approach is similar to the method suggested by Ko et al. [15] The loading/unloading curve consisted of four parts: during the first 3 s the probe is in electric contact with the surface with an applied load of 0.002 mN; then the force over the probe increases in 1 s to the maximum value $F_{max}$; in the third part the load decreases from $F_{max}$ to 0.002 mN, and finally the probe rests above the sample for 3 s to allow possible relaxation processes to occur. Ten indentations separated by a distance of 50 μm were made in each sample. In the second configuration (Fig. 1b) the converse piezoelectric effect is measured; when 40 V dc bias voltage is applied through the tip, the sample surface displacement is detected. A constant load of 10 μN was applied in order to keep the indenter tip in physical contact with the samples. This approach is similar to the method suggested by Rar et al. [10], but in our case the applied voltage is dc instead of ac.
Results and discussion

ToF-ERDA measurements showed all Sc$_x$Al$_{1-x}$N samples to be stoichiometric with the (Al+Sc)/N ratio being 1, and levels of Sc and Al constant throughout the film with accuracy of 3%. The composition of the films was determined to be $x=0$, $0.1$, $0.2$, and $0.3$. Here $x$ corresponds to a fraction of Sc in the total (Al+Sc).

XRD patterns from Sc$_x$Al$_{1-x}$N films with $x=0$, 0.1, 0.2, and 0.3 are shown in Fig. 2. The only observed peaks in the $\theta/2\theta$ scans correspond to wurtzite Sc$_x$Al$_{1-x}$N 0002 (film), cubic TiN 111 (seed layer), and Al$_2$O$_3$ 0006 (substrate). The Sc$_x$Al$_{1-x}$N peak intensity is decreasing, the peaks broaden, and the peak positions are shifting towards lower angles with increasing Sc concentration. Moreover, according to Sc$_x$Al$_{1-x}$N 0002 peak rocking curve measurements (not shown) full width at half maximum (FWHM) values increase from 0.452° for pure AlN to above 2° in samples with $x=0.3$. These results match observations from our previous growth study [3].

Recent theoretical studies show a linear decrease in bulk modulus $B$ for Sc$_x$Al$_{1-x}$N with up to $x=0.375$ [16] due to the deviation from tetrahedral bonding [5,17], the change in average bond lengths and lattice parameters [6], and the increasing bond ionicity that leads to reduction in shear moduli in tetrahedrally bonded semiconductors [18]. Fig. 3 shows experimentally obtained reduced elastic modulus $E_r$ and hardness $H$ of Sc$_x$Al$_{1-x}$N thin films as a function of Sc concentration. The hardness of AlN found in the literature varies in the range of 12-26 GPa [7,8], and in our case it is 17±0.45 GPa when $T_s=800$ °C. $E_r$ and $H$ obtained during the nanoindentation experiments show a decrease with the addition of Sc from 17 GPa in AlN to 11 GPa in Sc$_{0.3}$Al$_{0.7}$N, and from 265 GPa down to 224 GPa, respectively. Even if $E_r$ cannot be directly compared to a bulk modulus $B$, the 15.5% reduction in $E_r$ observed experimentally is close to the 14% theoretically predicted $B$ reduction in [16]. $E_r$ shows similar trends to experimental and theoretical Young’s modulus $E$ in [19] up to $x=0.2$, thus confirming the evolution of the elastic properties of Sc$_x$Al$_{1-x}$N with increasing $x$.

The results from PFM phase mapping are shown in Fig. 4. Here, the contrast comes from the phase difference between the applied ac signal and the piezoresponse. In the $c$-axis oriented wurtzite Sc$_x$Al$_{1-x}$N the anion-to-cation (N and Al/Sc, respectively) spontaneous polarization points along the $c$-axis. The “upward” N-polarity (0° phase angle) and “downward” Al-polarity (180° phase angle) are represented as dark and bright regions, respectively. The maps
show that on the 5x5 μm² scale all investigated films are uniform and have piezoelectric domains mostly in the “downward” direction. Small inclusions of the opposite polarization are observed, they could be attributed to morphological effects such as local film density variations due to columnar growth, as previously observed in TEM [3]. No trends with respect to the polarization-phase purity as a function of Sc concentration were found. A quantitative analysis, resulting in piezoelectric coefficients $d_{33}$ of Sc$_x$Al$_{1-x}$N thin films using the PFM in a similar experimental set-up, has been presented elsewhere [3].

Fig. 5a shows nanoindentation induced voltage response using the direct measurement setup (Fig. 1a), during a triangular loading/unloading. The voltage is shown as a function of time, during which the loading force was increased from $F=0.002$ mN up to $F_{m}=11$ mN. The increase in generated voltage was repeatable and it scaled with increased Sc concentration up to $x=0.2$. Peak voltages of $V_p=0.051$ V, $V_p=0.054$ V, $0.059$ V, and $0.020$ V were measured for the AlN, Sc$_{0.1}$Al$_{0.9}$N, Sc$_{0.2}$Al$_{0.8}$N, and Sc$_{0.3}$Al$_{0.7}$N, respectively. A slight bowing in electrical response during loading and unloading was observed (Fig. 5a). Additional experiments with multiple consecutive load/unload cycles (Fig. 5b) showed the voltage generation to be consistent and repeatable in all investigated samples. Such repeatability suggests that only elastic deformation participates in the voltage generation, as previously shown in [11] and [12]. Moreover, a set of experiments using a trapezoidal loading/unloading profile, where at $F_{m}=5$ mN the load was kept constant for 3 s, was performed to test the stability of the piezoresponse. Examples of such measurements in the AlN and Sc$_{0.1}$Al$_{0.9}$N samples are shown in Fig. 5c, and the response was stable for all investigated samples. While the initial bowing is present here as well, there is almost no change in generated voltage at the peak load over an extended period of time, proving the response to be stable and constant. Similar trends were previously observed during the characterization of PZT nanoislands and ZnO nanowires [11,12].

From Fig. 3 we can see that both hardness $H$ and elastic modulus $E_i$ of Sc$_x$Al$_{1-x}$N decrease when going from $x=0$
to $x=0.3$. This suggests that for the same load $F$ the penetration depth (displacement) will be different, and consequently, the generated piezo-voltage will vary depending on the Sc concentration. Fig. 6 shows the displacement curve together with generated voltage, and during the loading the two curves match very well. However, during the unloading, the displacement in the sample does not return to its initial zero value due to the plastic deformation. A non-linear relationship between the load and the penetration depth is attributed to local structural changes during the nanoindentation process [20,21], which may contribute to the bowing voltage response (Fig. 5a-c) that does not match the linear loading profile. The differences in hardness must therefore be taken into account for quantitative assessment of the piezoelectric properties of materials with different compositions, using the direct piezoelectric effect during nanoindentation.

This is illustrated in Fig. 7, which gives a summary of the results both for the a) generated voltage as a function of load (0.1-11 mN) and b) as a function of the displacement for $x=0$, 0.1, 0.2, and 0.3. In all investigated samples the generated voltage was increasing with the increasing load (Fig. 7a) and it was highest for samples with $x=0.2$, while samples with $x=0.3$ show a lower response than the reference AlN. On average, samples with $x=0.1$ showed up to +10%, and samples with $x=0.2$ has up to +15% increase in generated voltage response as compared to the reference AlN sample. When the generated voltage is plotted as a function of displacement (Fig. 7b) the responses from $\text{Sc}_{0.1}\text{Al}_{0.9}\text{N}$ and $\text{Sc}_{0.2}\text{Al}_{0.8}\text{N}$ become very similar, though the generated voltage in both of them is higher than for the AlN samples. These findings show that a quantitative or even a qualitative comparison between samples with different mechanical properties, characterized using the nanoindentation-based techniques, is not straightforward. In both Fig. 7a and Fig. 7b, the lowest generated voltage values were recorded for $\text{Sc}_{0.3}\text{Al}_{0.7}\text{N}$, in agreement with our previously published data obtained using the DBI and PFM [3], where samples with $x=0.3$ showed no piezoelectric response independently of growth temperature. The main reason is the degradation of microstructure caused by high Sc concentration. Selected area electron diffraction (SAED) patterns [3] for films with $x=0.3$ are composed of arc-like spots, in contrast to sharp spots corresponding to c-axis oriented wurtzite structure observed in AlN and samples with up to $x=0.2$.

As it is evident from Fig. 7, the hardness and the elastic modulus influence the piezoelectric response, as the softer material would be penetrated deeper at the same load, leading to higher generated voltage. A theoretical model of conical indenter in combination with experiments using PZT and BaTiO$_3$ ceramics [22] shows that the analytical predictions based on linear elasticity theory are only applicable before the plastic deformation takes place. The complex strain field, that can be expected to be generated by the anisotropic Berkovich tip in a single crystal specimen, in combination with the large plastic deformation suggest that the piezoelectric coefficients, $e_{13}$, cannot be analytically be determined using common linear elasticity theory from our direct piezoelectric response data using the nanoindenter.

On the other hand, the method of utilizing the converse piezoelectric effect, where a voltage is applied and the displacement is measured by the tip under a very low load, is a much gentler process which does not involve any plastic deformation and induces a minimum of elastic distortion thanks to the ~3 orders of magnitude lower contact force, as compared to the direct method. Therefore, in order to overcome the hurdles experienced with the direct method, the converse piezoelectric measurements were also performed using the nanoindenter, with the setup shown in Fig. 1b. Upon applying a +40 V bias voltage to the conductive Berkovich tip for 5 s, the induced vertical displacement of the films was measured. At lower bias voltage the noise level was too high to obtain accurate and reliable data with our current setup. The results for AlN and $\text{Sc}_x\text{Al}_{1-x}\text{N}$ ($x=0.1$, 0.2, and 0.3) are shown in Fig. 8a, where 50 Hz power-line noise has been filtered out after the measurement using a low-pass filter. The response to the applied +40 V was fast and repeatable in all samples, and the displacement increased with Sc concentration for $x=0.1$ and 0.2 as compared to AlN. However, the piezoelectric response of $\text{Sc}_{0.3}\text{Al}_{0.7}\text{N}$ was lower than for the other investigated samples, in agreement with our observations during the direct piezoelectric measurement (Fig. 5a). Recent studies show, that piezoelectric properties of AlN depend
on the film thickness, however, $d_{33}$ increases only by about 5\% when thickness is increased from 250 to 500 nm [23]. The influence of thickness variations in Figure 8 can be considered inside the experimental error, and do not change the observed trends.

The extraction of $d_{33,dc}\Delta l/\Delta V$ values from such measurements is only possible in two-dimensional structures, such as piezoelectric nanowires [11], where the elongation $\Delta l$ induced by applied voltage in the out of plane direction is not constrained in-plane, as it is in the continuous film. Therefore, for a qualitative comparison, the averaged surface displacement as a function of Sc concentration was normalized to the reference AlN and is presented in Fig. 8b. The increase in displacement is close to linear up to $x=0.2$, and then decreases for the sample with $x=0.3$. The observed increase in the displacement is more than 360\% which is larger as compared to our previously published DBI and PFM results [3], in which a 180\% increase was observed. It should be noted that the results in Ref. [3] also are qualitative, with AlN as a reference, due to difficulties in obtaining absolute data with both DBI and PFM. The difference between that data and those presented here, based on the converse effect in nanoindentation, might thus be due to uncertainties in any of the three methods as well as different setups used, e.g., different electrode geometries.

For example, the complex electric field around the indenter tip and in the film due to the non-flat anisotropic indenter geometry, as well as ~10 times higher applied voltage may play a role for the converse nanoindentation method. The good qualitative data obtained and the ease of setting up and carrying through the converse piezoelectric measurement with the nanoindenter is very promising. Although it is beyond the scope of this work, a quantification of possible sources of errors should be pursued in order to facilitate absolute data acquisition in the future.

4 Conclusion Wurtzite Sc$_x$Al$_{1-x}$N(0001) thin films ($x=0, 0.1, 0.2, 0.3$) deposited on TiN(111)/Al$_2$O$_3$ were grown by reactive magnetron sputter epitaxy at $T_e=400$ °C. The crystal quality of the material decreased with increased Sc concentration as seen in the XRD patterns. PFM mapping showed all films to be homogeneous with respect to the piezoelectric phase. Hardness and reduced elastic modulus $E_r$ obtained from the nanoindentation experiments decreased with the addition of Sc from 17 GPa in AlN to 11 GPa in Sc$_{0.3}$Al$_{0.7}$N, and 265 GPa down to 224 GPa, respectively, and corroborate recent theoretical predictions of Sc$_x$Al$_{1-x}$N elastic constants. The same nanoindentation set up with a conductive boron doped Berkovich tip was used for piezoelectric characterization of the films. Samples with $x=0.3$ showed a diminished piezoelectric response both in the direct and converse measurement mode, in agreement with our previously published work. The direct piezoelectric effect was induced by applying 0.1–11 mN load to generate voltage up to 0.059 V for $x=0.2$. Bowing observed in the generated voltage response during the loading/unloading of the tip could be explained by the displacement (penetration depth) differences due to the diverse mechanical properties of the films, and the non-linear behavior typical for the plastic deformation during the nanoindentation process. The converse piezoelectric effect was induced by using the $dc$ PNI method at bias voltage of +440 V. In all samples the piezoelectric response, observed as the surface displacement, was fast and repeatable, and increased with the respect to Sc concentration up to $x=0.2$.

Acknowledgements We acknowledge the financial support by the Linköping Linnaeus Initiative on Nanoscale Functional Materials (LiLiNFM) provided by the Swedish Research Council (VR) under grant No.349-2008-6582. We would also like to acknowledge the contribution by Dr. Gunilla Wingqvist both in experimental work and the discussions. L.H. and E.B. also acknowledge the Swedish Government Strategic Research Area in Materials Science on Functional Materials at Linköping University (Faculty Grant SFO-Mat-LiU #2009-00971). J.B. acknowledges Linkoping University for providing financial support through a personal “Professor’s Contract”.

References

Figure 8 (a) Surface displacement in AlN (black), Sc$_{0.2}$Al$_{0.8}$ (red), Sc$_{0.5}$Al$_{0.5}$N (green), and Sc$_{0.3}$Al$_{0.7}$N (blue), caused by the applied bias voltage (40 V) during a piezoelectric nanoindentation measurement. (b) Relative piezoelectric response as a function of Sc concentration in Sc$_x$Al$_{1-x}$N(0001) obtained from the converse measurements. The dashed line is a guide the eyes only.

Copyright line will be provided by the publisher